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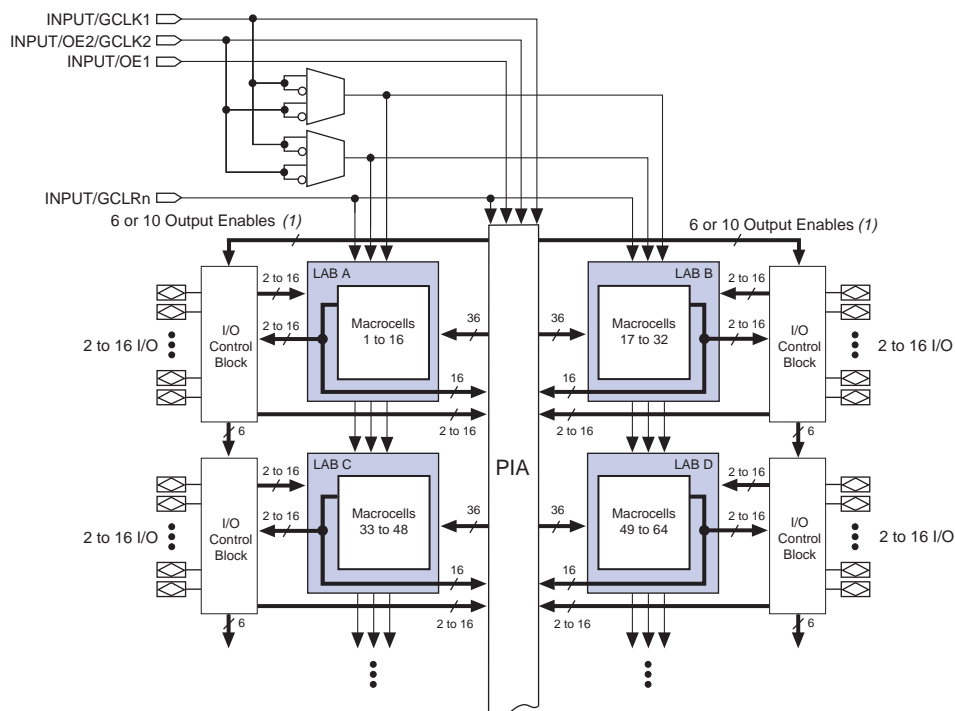
Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details

| | |
|---------------------------------|---|
| Product Status | Obsolete |
| Programmable Type | In System Programmable |
| Delay Time tpd(1) Max | 7.5 ns |
| Voltage Supply - Internal | 3V ~ 3.6V |
| Number of Logic Elements/Blocks | 16 |
| Number of Macrocells | 256 |
| Number of Gates | 5000 |
| Number of I/O | 84 |
| Operating Temperature | -40°C ~ 85°C (TA) |
| Mounting Type | Surface Mount |
| Package / Case | 100-TQFP |
| Supplier Device Package | 100-TQFP (14x14) |
| Purchase URL | https://www.e-xfl.com/product-detail/intel/epm7256aeti100-7 |

Figure 1. MAX 7000A Device Block Diagram**Note:**

- (1) EPM7032AE, EPM7064AE, EPM7128A, EPM7128AE, EPM7256A, and EPM7256AE devices have six output enables. EPM7512AE devices have 10 output enables.

Logic Array Blocks

The MAX 7000A device architecture is based on the linking of high-performance LABs. LABs consist of 16-macrocell arrays, as shown in [Figure 1](#). Multiple LABs are linked together via the PIA, a global bus that is fed by all dedicated input pins, I/O pins, and macrocells.

Each LAB is fed by the following signals:

- 36 signals from the PIA that are used for general logic inputs
- Global controls that are used for secondary register functions
- Direct input paths from I/O pins to the registers that are used for fast setup times

Expander Product Terms

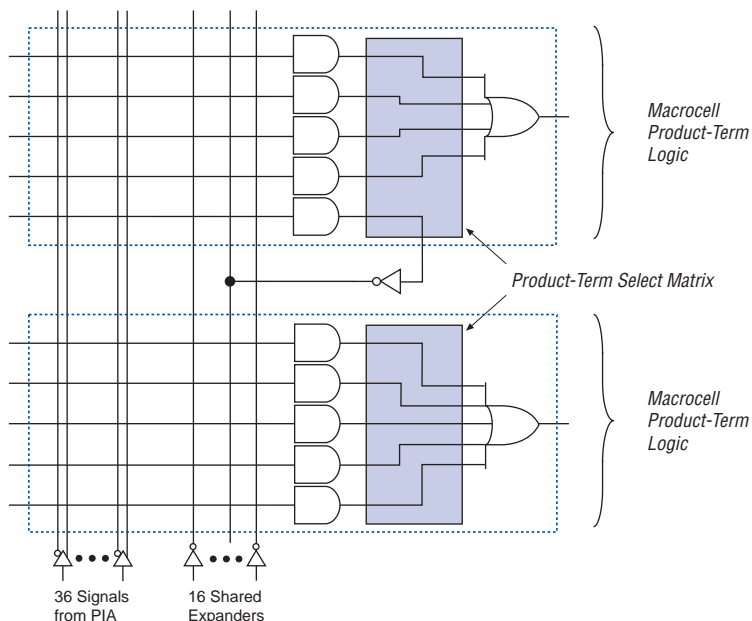
Although most logic functions can be implemented with the five product terms available in each macrocell, more complex logic functions require additional product terms. Another macrocell can be used to supply the required logic resources. However, the MAX 7000A architecture also offers both shareable and parallel expander product terms that provide additional product terms directly to any macrocell in the same LAB. These expanders help ensure that logic is synthesized with the fewest possible logic resources to obtain the fastest possible speed.

Shareable Expanders

Each LAB has 16 shareable expanders that can be viewed as a pool of uncommitted single product terms (one from each macrocell) with inverted outputs that feed back into the logic array. Each shareable expander can be used and shared by any or all macrocells in the LAB to build complex logic functions. A small delay (t_{SEXP}) is incurred when shareable expanders are used. Figure 3 shows how shareable expanders can feed multiple macrocells.

Figure 3. MAX 7000A Shareable Expanders

Shareable expanders can be shared by any or all macrocells in an LAB.

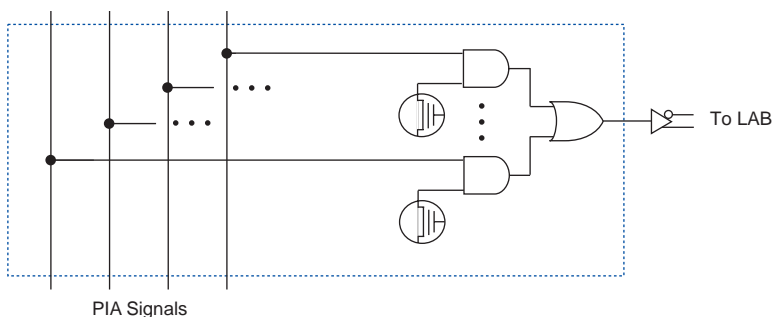


Parallel Expanders

Parallel expanders are unused product terms that can be allocated to a neighboring macrocell to implement fast, complex logic functions. Parallel expanders allow up to 20 product terms to directly feed the macrocell OR logic, with five product terms provided by the macrocell and 15 parallel expanders provided by neighboring macrocells in the LAB.

The compiler can allocate up to three sets of up to five parallel expanders to the macrocells that require additional product terms. Each set of five parallel expanders incurs a small, incremental timing delay (t_{PEXP}). For example, if a macrocell requires 14 product terms, the compiler uses the five dedicated product terms within the macrocell and allocates two sets of parallel expanders; the first set includes five product terms, and the second set includes four product terms, increasing the total delay by $2 \times t_{PEXP}$.

Two groups of eight macrocells within each LAB (e.g., macrocells 1 through 8 and 9 through 16) form two chains to lend or borrow parallel expanders. A macrocell borrows parallel expanders from lower-numbered macrocells. For example, macrocell 8 can borrow parallel expanders from macrocell 7, from macrocells 7 and 6, or from macrocells 7, 6, and 5. Within each group of eight, the lowest-numbered macrocell can only lend parallel expanders, and the highest-numbered macrocell can only borrow them. [Figure 4](#) shows how parallel expanders can be borrowed from a neighboring macrocell.

Figure 5. MAX 7000A PIA Routing

While the routing delays of channel-based routing schemes in masked or FPGAs are cumulative, variable, and path-dependent, the MAX 7000A PIA has a predictable delay. The PIA makes a design's timing performance easy to predict.

I/O Control Blocks

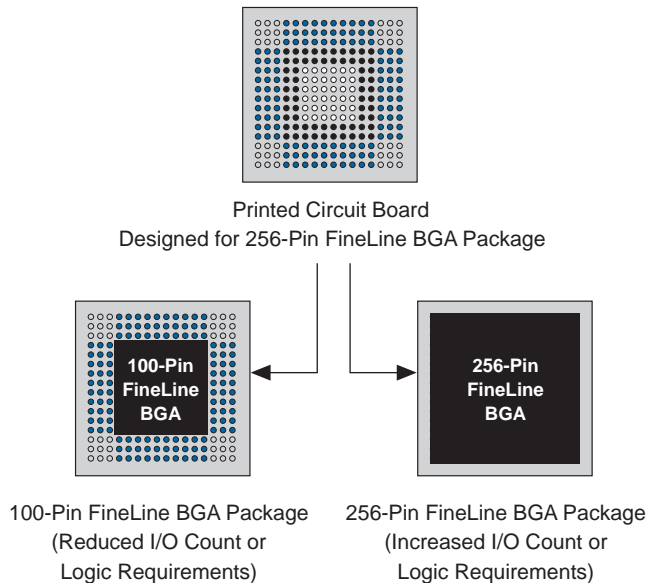
The I/O control block allows each I/O pin to be individually configured for input, output, or bidirectional operation. All I/O pins have a tri-state buffer that is individually controlled by one of the global output enable signals or directly connected to ground or V_{CC} . Figure 6 shows the I/O control block for MAX 7000A devices. The I/O control block has 6 or 10 global output enable signals that are driven by the true or complement of two output enable signals, a subset of the I/O pins, or a subset of the I/O macrocells.

SameFrame Pin-Outs

MAX 7000A devices support the SameFrame pin-out feature for FineLine BGA packages. The SameFrame pin-out feature is the arrangement of balls on FineLine BGA packages such that the lower-ball-count packages form a subset of the higher-ball-count packages. SameFrame pin-outs provide the flexibility to migrate not only from device to device within the same package, but also from one package to another. A given printed circuit board (PCB) layout can support multiple device density/package combinations. For example, a single board layout can support a range of devices from an EPM7128AE device in a 100-pin FineLine BGA package to an EPM7512AE device in a 256-pin FineLine BGA package.

The Altera design software provides support to design PCBs with SameFrame pin-out devices. Devices can be defined for present and future use. The software generates pin-outs describing how to lay out a board to take advantage of this migration (see [Figure 7](#)).

Figure 7. SameFrame Pin-Out Example



In-System Programmability

MAX 7000A devices can be programmed in-system via an industry-standard 4-pin IEEE Std. 1149.1 (JTAG) interface. ISP offers quick, efficient iterations during design development and debugging cycles. The MAX 7000A architecture internally generates the high programming voltages required to program EEPROM cells, allowing in-system programming with only a single 3.3-V power supply. During in-system programming, the I/O pins are tri-stated and weakly pulled-up to eliminate board conflicts. The pull-up value is nominally 50 k Ω .

MAX 7000AE devices have an enhanced ISP algorithm for faster programming. These devices also offer an ISP_Done bit that provides safe operation when in-system programming is interrupted. This ISP_Done bit, which is the last bit programmed, prevents all I/O pins from driving until the bit is programmed. This feature is only available in EPM7032AE, EPM7064AE, EPM7128AE, EPM7256AE, and EPM7512AE devices.

ISP simplifies the manufacturing flow by allowing devices to be mounted on a PCB with standard pick-and-place equipment before they are programmed. MAX 7000A devices can be programmed by downloading the information via in-circuit testers, embedded processors, the Altera MasterBlaster serial/USB communications cable, ByteBlasterMV parallel port download cable, and BitBlaster serial download cable. Programming the devices after they are placed on the board eliminates lead damage on high-pin-count packages (e.g., QFP packages) due to device handling. MAX 7000A devices can be reprogrammed after a system has already shipped to the field. For example, product upgrades can be performed in the field via software or modem.

In-system programming can be accomplished with either an adaptive or constant algorithm. An adaptive algorithm reads information from the unit and adapts subsequent programming steps to achieve the fastest possible programming time for that unit. A constant algorithm uses a pre-defined (non-adaptive) programming sequence that does not take advantage of adaptive algorithm programming time improvements. Some in-circuit testers cannot program using an adaptive algorithm. Therefore, a constant algorithm must be used. MAX 7000AE devices can be programmed with either an adaptive or constant (non-adaptive) algorithm. EPM7128A and EPM7256A device can only be programmed with an adaptive algorithm; users programming these two devices on platforms that cannot use an adaptive algorithm should use EPM7128AE and EPM7256AE devices.

The Jam Standard Test and Programming Language (STAPL), JEDEC standard JESD 71, can be used to program MAX 7000A devices with in-circuit testers, PCs, or embedded processors.



For more information on using the Jam STAPL language, see *Application Note 88 (Using the Jam Language for ISP & ICR via an Embedded Processor)* and *Application Note 122 (Using Jam STAPL for ISP & ICR via an Embedded Processor)*.

ISP circuitry in MAX 7000AE devices is compliant with the IEEE Std. 1532 specification. The IEEE Std. 1532 is a standard developed to allow concurrent ISP between multiple PLD vendors.

Programming Sequence

During in-system programming, instructions, addresses, and data are shifted into the MAX 7000A device through the TDI input pin. Data is shifted out through the TDO output pin and compared against the expected data.

Programming a pattern into the device requires the following six ISP stages. A stand-alone verification of a programmed pattern involves only stages 1, 2, 5, and 6.

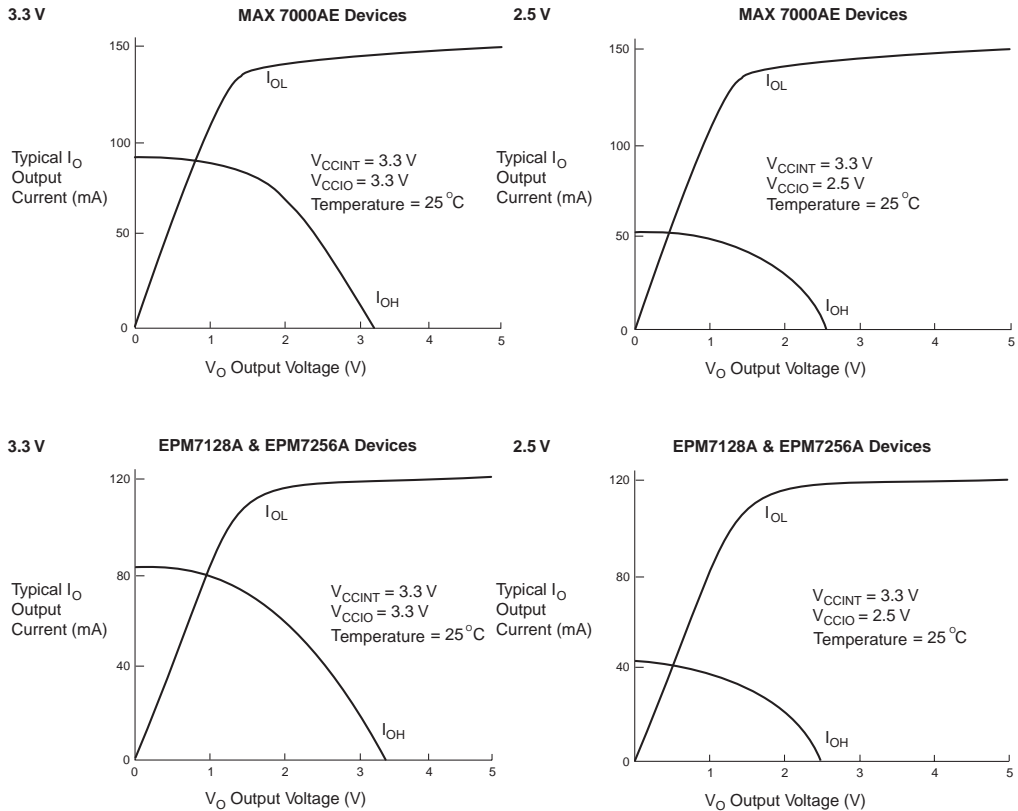
1. *Enter ISP.* The enter ISP stage ensures that the I/O pins transition smoothly from user mode to ISP mode. The enter ISP stage requires 1 ms.
2. *Check ID.* Before any program or verify process, the silicon ID is checked. The time required to read this silicon ID is relatively small compared to the overall programming time.
3. *Bulk Erase.* Erasing the device in-system involves shifting in the instructions to erase the device and applying one erase pulse of 100 ms.
4. *Program.* Programming the device in-system involves shifting in the address and data and then applying the programming pulse to program the EEPROM cells. This process is repeated for each EEPROM address.
5. *Verify.* Verifying an Altera device in-system involves shifting in addresses, applying the read pulse to verify the EEPROM cells, and shifting out the data for comparison. This process is repeated for each EEPROM address.
6. *Exit ISP.* An exit ISP stage ensures that the I/O pins transition smoothly from ISP mode to user mode. The exit ISP stage requires 1 ms.

Table 8. MAX 7000A JTAG Instructions

| JTAG Instruction | Description |
|------------------|--|
| SAMPLE/PRELOAD | Allows a snapshot of signals at the device pins to be captured and examined during normal device operation, and permits an initial data pattern output at the device pins |
| EXTEST | Allows the external circuitry and board-level interconnections to be tested by forcing a test pattern at the output pins and capturing test results at the input pins |
| BYPASS | Places the 1-bit bypass register between the TDI and TDO pins, which allows the BST data to pass synchronously through a selected device to adjacent devices during normal device operation |
| IDCODE | Selects the IDCODE register and places it between the TDI and TDO pins, allowing the IDCODE to be serially shifted out of TDO |
| USERCODE | Selects the 32-bit USERCODE register and places it between the TDI and TDO pins, allowing the USERCODE value to be shifted out of TDO. The USERCODE instruction is available for MAX 7000AE devices only |
| UESCODE | These instructions select the user electronic signature (UESCODE) and allow the UESCODE to be shifted out of TDO. UESCODE instructions are available for EPM7128A and EPM7256A devices only. |
| ISP Instructions | These instructions are used when programming MAX 7000A devices via the JTAG ports with the MasterBlaster, ByteBlasterMV, or BitBlaster download cable, or using a Jam STAPL File, JBC File, or SVF File via an embedded processor or test equipment. |

Figure 10 shows the typical output drive characteristics of MAX 7000A devices.

Figure 10. Output Drive Characteristics of MAX 7000A Devices



Timing Model

MAX 7000A device timing can be analyzed with the Altera software, a variety of popular industry-standard EDA simulators and timing analyzers, or with the timing model shown in Figure 11. MAX 7000A devices have predictable internal delays that enable the designer to determine the worst-case timing of any design. The software provides timing simulation, point-to-point delay prediction, and detailed timing analysis for device-wide performance evaluation.

Tables 17 through 30 show EPM7032AE, EPM7064AE, EPM7128AE, EPM7256AE, EPM7512AE, EPM7128A, and EPM7256A timing information.

Table 17. EPM7032AE External Timing Parameters *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | Unit |
|-------------------|--|----------------|-------------|-----|-------|-----|-------|-----|------|
| | | | -4 | | -7 | | -10 | | |
| | | | Min | Max | Min | Max | Min | Max | |
| t _{PD1} | Input to non-registered output | C1 = 35 pF (2) | | 4.5 | | 7.5 | | 10 | ns |
| t _{PD2} | I/O input to non-registered output | C1 = 35 pF (2) | | 4.5 | | 7.5 | | 10 | ns |
| t _{SU} | Global clock setup time | (2) | 2.9 | | 4.7 | | 6.3 | | ns |
| t _H | Global clock hold time | (2) | 0.0 | | 0.0 | | 0.0 | | ns |
| t _{FSU} | Global clock setup time of fast input | | 2.5 | | 3.0 | | 3.0 | | ns |
| t _{FH} | Global clock hold time of fast input | | 0.0 | | 0.0 | | 0.0 | | ns |
| t _{CO1} | Global clock to output delay | C1 = 35 pF | 1.0 | 3.0 | 1.0 | 5.0 | 1.0 | 6.7 | ns |
| t _{CH} | Global clock high time | | 2.0 | | 3.0 | | 4.0 | | ns |
| t _{CL} | Global clock low time | | 2.0 | | 3.0 | | 4.0 | | ns |
| t _{ASU} | Array clock setup time | (2) | 1.6 | | 2.5 | | 3.6 | | ns |
| t _{AH} | Array clock hold time | (2) | 0.3 | | 0.5 | | 0.5 | | ns |
| t _{ACO1} | Array clock to output delay | C1 = 35 pF (2) | 1.0 | 4.3 | 1.0 | 7.2 | 1.0 | 9.4 | ns |
| t _{ACH} | Array clock high time | | 2.0 | | 3.0 | | 4.0 | | ns |
| t _{ACL} | Array clock low time | | 2.0 | | 3.0 | | 4.0 | | ns |
| t _{CPPW} | Minimum pulse width for clear and preset | (3) | 2.0 | | 3.0 | | 4.0 | | ns |
| t _{CNT} | Minimum global clock period | (2) | | 4.4 | | 7.2 | | 9.7 | ns |
| f _{CNT} | Maximum internal global clock frequency | (2), (4) | 227.3 | | 138.9 | | 103.1 | | MHz |
| t _{ACNT} | Minimum array clock period | (2) | | 4.4 | | 7.2 | | 9.7 | ns |
| f _{ACNT} | Maximum internal array clock frequency | (2), (4) | 227.3 | | 138.9 | | 103.1 | | MHz |

Table 20. EPM7064AE Internal Timing Parameters (Part 1 of 2) *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | Unit |
|------------|---|----------------------------|-------------|-----|-----|-----|-----|------|------|
| | | | -4 | | -7 | | -10 | | |
| | | | Min | Max | Min | Max | Min | Max | |
| t_{IN} | Input pad and buffer delay | | | 0.6 | | 1.1 | | 1.4 | ns |
| t_{IO} | I/O input pad and buffer delay | | | 0.6 | | 1.1 | | 1.4 | ns |
| t_{FIN} | Fast input delay | | | 2.5 | | 3.0 | | 3.7 | ns |
| t_{SEXP} | Shared expander delay | | | 1.8 | | 3.0 | | 3.9 | ns |
| t_{PEXP} | Parallel expander delay | | | 0.4 | | 0.7 | | 0.9 | ns |
| t_{LAD} | Logic array delay | | | 1.5 | | 2.5 | | 3.2 | ns |
| t_{LAC} | Logic control array delay | | | 0.6 | | 1.0 | | 1.2 | ns |
| t_{IOE} | Internal output enable delay | | | 0.0 | | 0.0 | | 0.0 | ns |
| t_{OD1} | Output buffer and pad delay, slow slew rate = off $V_{CCIO} = 3.3\text{ V}$ | $C1 = 35\text{ pF}$ | | 0.8 | | 1.3 | | 1.8 | ns |
| t_{OD2} | Output buffer and pad delay, slow slew rate = off $V_{CCIO} = 2.5\text{ V}$ | $C1 = 35\text{ pF}$ (5) | | 1.3 | | 1.8 | | 2.3 | ns |
| t_{OD3} | Output buffer and pad delay, slow slew rate = on $V_{CCIO} = 2.5\text{ V}$ or 3.3 V | $C1 = 35\text{ pF}$ | | 5.8 | | 6.3 | | 6.8 | ns |
| t_{ZX1} | Output buffer enable delay, slow slew rate = off $V_{CCIO} = 3.3\text{ V}$ | $C1 = 35\text{ pF}$ | | 4.0 | | 4.0 | | 5.0 | ns |
| t_{ZX2} | Output buffer enable delay, slow slew rate = off $V_{CCIO} = 2.5\text{ V}$ | $C1 = 35\text{ pF}$ (5) | | 4.5 | | 4.5 | | 5.5 | ns |
| t_{ZX3} | Output buffer enable delay, slow slew rate = on $V_{CCIO} = 3.3\text{ V}$ | $C1 = 35\text{ pF}$ | | 9.0 | | 9.0 | | 10.0 | ns |
| t_{XZ} | Output buffer disable delay | $C1 = 5\text{ pF}$ | | 4.0 | | 4.0 | | 5.0 | ns |
| t_{SU} | Register setup time | | 1.3 | | 2.0 | | 2.9 | | ns |
| t_H | Register hold time | | 0.6 | | 1.0 | | 1.3 | | ns |
| t_{FSU} | Register setup time of fast input | | 1.0 | | 1.5 | | 1.5 | | ns |
| t_{FH} | Register hold time of fast input | | 1.5 | | 1.5 | | 1.5 | | ns |
| t_{RD} | Register delay | | | 0.7 | | 1.2 | | 1.6 | ns |
| t_{COMB} | Combinatorial delay | | | 0.6 | | 0.9 | | 1.3 | ns |
| t_{IC} | Array clock delay | | | 1.2 | | 1.9 | | 2.5 | ns |

Table 22. EPM7128AE Internal Timing Parameters (Part 1 of 2) *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | Unit |
|------------|---|----------------------------|-------------|-----|-----|-----|-----|------|------|
| | | | -5 | | -7 | | -10 | | |
| | | | Min | Max | Min | Max | Min | Max | |
| t_{IN} | Input pad and buffer delay | | | 0.7 | | 1.0 | | 1.4 | ns |
| t_{IO} | I/O input pad and buffer delay | | | 0.7 | | 1.0 | | 1.4 | ns |
| t_{FIN} | Fast input delay | | | 2.5 | | 3.0 | | 3.4 | ns |
| t_{SEXP} | Shared expander delay | | | 2.0 | | 2.9 | | 3.8 | ns |
| t_{PEXP} | Parallel expander delay | | | 0.4 | | 0.7 | | 0.9 | ns |
| t_{LAD} | Logic array delay | | | 1.6 | | 2.4 | | 3.1 | ns |
| t_{LAC} | Logic control array delay | | | 0.7 | | 1.0 | | 1.3 | ns |
| t_{IOE} | Internal output enable delay | | | 0.0 | | 0.0 | | 0.0 | ns |
| t_{OD1} | Output buffer and pad delay, slow slew rate = off $V_{CCIO} = 3.3\text{ V}$ | $C1 = 35\text{ pF}$ | | 0.8 | | 1.2 | | 1.6 | ns |
| t_{OD2} | Output buffer and pad delay, slow slew rate = off $V_{CCIO} = 2.5\text{ V}$ | $C1 = 35\text{ pF}$ (5) | | 1.3 | | 1.7 | | 2.1 | ns |
| t_{OD3} | Output buffer and pad delay, slow slew rate = on $V_{CCIO} = 2.5\text{ V}$ or 3.3 V | $C1 = 35\text{ pF}$ | | 5.8 | | 6.2 | | 6.6 | ns |
| t_{ZX1} | Output buffer enable delay, slow slew rate = off $V_{CCIO} = 3.3\text{ V}$ | $C1 = 35\text{ pF}$ | | 4.0 | | 4.0 | | 5.0 | ns |
| t_{ZX2} | Output buffer enable delay, slow slew rate = off $V_{CCIO} = 2.5\text{ V}$ | $C1 = 35\text{ pF}$ (5) | | 4.5 | | 4.5 | | 5.5 | ns |
| t_{ZX3} | Output buffer enable delay, slow slew rate = on $V_{CCIO} = 3.3\text{ V}$ | $C1 = 35\text{ pF}$ | | 9.0 | | 9.0 | | 10.0 | ns |
| t_{XZ} | Output buffer disable delay | $C1 = 5\text{ pF}$ | | 4.0 | | 4.0 | | 5.0 | ns |
| t_{SU} | Register setup time | | 1.4 | | 2.1 | | 2.9 | | ns |
| t_H | Register hold time | | 0.6 | | 1.0 | | 1.3 | | ns |
| t_{FSU} | Register setup time of fast input | | 1.1 | | 1.6 | | 1.6 | | ns |
| t_{FH} | Register hold time of fast input | | 1.4 | | 1.4 | | 1.4 | | ns |
| t_{RD} | Register delay | | | 0.8 | | 1.2 | | 1.6 | ns |
| t_{COMB} | Combinatorial delay | | | 0.5 | | 0.9 | | 1.3 | ns |
| t_{IC} | Array clock delay | | | 1.2 | | 1.7 | | 2.2 | ns |

Table 22. EPM7128AE Internal Timing Parameters (Part 2 of 2) *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | Unit |
|------------|----------------------|------------|-------------|-----|-----|-----|-----|-----|------|
| | | | -5 | | -7 | | -10 | | |
| | | | Min | Max | Min | Max | Min | Max | |
| t_{EN} | Register enable time | | | 0.7 | | 1.0 | | 1.3 | ns |
| t_{GLOB} | Global control delay | | | 1.1 | | 1.6 | | 2.0 | ns |
| t_{PRE} | Register preset time | | | 1.4 | | 2.0 | | 2.7 | ns |
| t_{CLR} | Register clear time | | | 1.4 | | 2.0 | | 2.7 | ns |
| t_{PIA} | PIA delay | (2) | | 1.4 | | 2.0 | | 2.6 | ns |
| t_{LPA} | Low-power adder | (6) | | 4.0 | | 4.0 | | 5.0 | ns |

Table 23. EPM7256AE External Timing Parameters *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | Unit |
|-------------------|--|-------------------|-------------|-----|-------|-----|------|------|------|
| | | | -5 | | -7 | | -10 | | |
| | | | Min | Max | Min | Max | Min | Max | |
| t _{PD1} | Input to non-registered output | C1 = 35 pF (2) | | 5.5 | | 7.5 | | 10 | ns |
| t _{PD2} | I/O input to non-registered output | C1 = 35 pF (2) | | 5.5 | | 7.5 | | 10 | ns |
| t _{SU} | Global clock setup time | (2) | 3.9 | | 5.2 | | 6.9 | | ns |
| t _H | Global clock hold time | (2) | 0.0 | | 0.0 | | 0.0 | | ns |
| t _{FSU} | Global clock setup time of fast input | | 2.5 | | 3.0 | | 3.0 | | ns |
| t _{FH} | Global clock hold time of fast input | | 0.0 | | 0.0 | | 0.0 | | ns |
| t _{CO1} | Global clock to output delay | C1 = 35 pF | 1.0 | 3.5 | 1.0 | 4.8 | 1.0 | 6.4 | ns |
| t _{CH} | Global clock high time | | 2.0 | | 3.0 | | 4.0 | | ns |
| t _{CL} | Global clock low time | | 2.0 | | 3.0 | | 4.0 | | ns |
| t _{ASU} | Array clock setup time | (2) | 2.0 | | 2.7 | | 3.6 | | ns |
| t _{AH} | Array clock hold time | (2) | 0.2 | | 0.3 | | 0.5 | | ns |
| t _{ACO1} | Array clock to output delay | C1 = 35 pF (2) | 1.0 | 5.4 | 1.0 | 7.3 | 1.0 | 9.7 | ns |
| t _{ACH} | Array clock high time | | 2.0 | | 3.0 | | 4.0 | | ns |
| t _{ACL} | Array clock low time | | 2.0 | | 3.0 | | 4.0 | | ns |
| t _{CPPW} | Minimum pulse width for clear and preset | (3) | 2.0 | | 3.0 | | 4.0 | | ns |
| t _{CNT} | Minimum global clock period | (2) | | 5.8 | | 7.9 | | 10.5 | ns |
| f _{CNT} | Maximum internal global clock frequency | (2), (4) | 172.4 | | 126.6 | | 95.2 | | MHz |
| t _{ACNT} | Minimum array clock period | (2) | | 5.8 | | 7.9 | | 10.5 | ns |
| f _{ACNT} | Maximum internal array clock frequency | (2), (4) | 172.4 | | 126.6 | | 95.2 | | MHz |

Table 24. EPM7256AE Internal Timing Parameters (Part 1 of 2) *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | Unit |
|------------|---|----------------------------|-------------|-----|-----|-----|-----|------|------|
| | | | -5 | | -7 | | -10 | | |
| | | | Min | Max | Min | Max | Min | Max | |
| t_{IN} | Input pad and buffer delay | | | 0.7 | | 0.9 | | 1.2 | ns |
| t_{IO} | I/O input pad and buffer delay | | | 0.7 | | 0.9 | | 1.2 | ns |
| t_{FIN} | Fast input delay | | | 2.4 | | 2.9 | | 3.4 | ns |
| t_{SEXP} | Shared expander delay | | | 2.1 | | 2.8 | | 3.7 | ns |
| t_{PEXP} | Parallel expander delay | | | 0.3 | | 0.5 | | 0.6 | ns |
| t_{LAD} | Logic array delay | | | 1.7 | | 2.2 | | 2.8 | ns |
| t_{LAC} | Logic control array delay | | | 0.8 | | 1.0 | | 1.3 | ns |
| t_{IOE} | Internal output enable delay | | | 0.0 | | 0.0 | | 0.0 | ns |
| t_{OD1} | Output buffer and pad delay, slow slew rate = off $V_{CCIO} = 3.3\text{ V}$ | $C1 = 35\text{ pF}$ | | 0.9 | | 1.2 | | 1.6 | ns |
| t_{OD2} | Output buffer and pad delay, slow slew rate = off $V_{CCIO} = 2.5\text{ V}$ | $C1 = 35\text{ pF}$ (5) | | 1.4 | | 1.7 | | 2.1 | ns |
| t_{OD3} | Output buffer and pad delay, slow slew rate = on $V_{CCIO} = 2.5\text{ V}$ or 3.3 V | $C1 = 35\text{ pF}$ | | 5.9 | | 6.2 | | 6.6 | ns |
| t_{ZX1} | Output buffer enable delay, slow slew rate = off $V_{CCIO} = 3.3\text{ V}$ | $C1 = 35\text{ pF}$ | | 4.0 | | 4.0 | | 5.0 | ns |
| t_{ZX2} | Output buffer enable delay, slow slew rate = off $V_{CCIO} = 2.5\text{ V}$ | $C1 = 35\text{ pF}$ (5) | | 4.5 | | 4.5 | | 5.5 | ns |
| t_{ZX3} | Output buffer enable delay, slow slew rate = on $V_{CCIO} = 3.3\text{ V}$ | $C1 = 35\text{ pF}$ | | 9.0 | | 9.0 | | 10.0 | ns |
| t_{XZ} | Output buffer disable delay | $C1 = 5\text{ pF}$ | | 4.0 | | 4.0 | | 5.0 | ns |
| t_{SU} | Register setup time | | 1.5 | | 2.1 | | 2.9 | | ns |
| t_H | Register hold time | | 0.7 | | 0.9 | | 1.2 | | ns |
| t_{FSU} | Register setup time of fast input | | 1.1 | | 1.6 | | 1.6 | | ns |
| t_{FH} | Register hold time of fast input | | 1.4 | | 1.4 | | 1.4 | | ns |
| t_{RD} | Register delay | | | 0.9 | | 1.2 | | 1.6 | ns |
| t_{COMB} | Combinatorial delay | | | 0.5 | | 0.8 | | 1.2 | ns |

Table 25. EPM7512AE External Timing Parameters *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | Unit |
|-------------------|--|-------------------|-------------|-----|------|------|------|------|------|
| | | | -7 | | -10 | | -12 | | |
| | | | Min | Max | Min | Max | Min | Max | |
| t _{PD1} | Input to non-registered output | C1 = 35 pF (2) | | 7.5 | | 10.0 | | 12.0 | ns |
| t _{PD2} | I/O input to non-registered output | C1 = 35 pF (2) | | 7.5 | | 10.0 | | 12.0 | ns |
| t _{SU} | Global clock setup time | (2) | 5.6 | | 7.6 | | 9.1 | | ns |
| t _H | Global clock hold time | (2) | 0.0 | | 0.0 | | 0.0 | | ns |
| t _{FSU} | Global clock setup time of fast input | | 3.0 | | 3.0 | | 3.0 | | ns |
| t _{FH} | Global clock hold time of fast input | | 0.0 | | 0.0 | | 0.0 | | ns |
| t _{CO1} | Global clock to output delay | C1 = 35 pF | 1.0 | 4.7 | 1.0 | 6.3 | 1.0 | 7.5 | ns |
| t _{CH} | Global clock high time | | 3.0 | | 4.0 | | 5.0 | | ns |
| t _{CL} | Global clock low time | | 3.0 | | 4.0 | | 5.0 | | ns |
| t _{ASU} | Array clock setup time | (2) | 2.5 | | 3.5 | | 4.1 | | ns |
| t _{AH} | Array clock hold time | (2) | 0.2 | | 0.3 | | 0.4 | | ns |
| t _{ACO1} | Array clock to output delay | C1 = 35 pF (2) | 1.0 | 7.8 | 1.0 | 10.4 | 1.0 | 12.5 | ns |
| t _{ACH} | Array clock high time | | 3.0 | | 4.0 | | 5.0 | | ns |
| t _{ACL} | Array clock low time | | 3.0 | | 4.0 | | 5.0 | | ns |
| t _{CPPW} | Minimum pulse width for clear and preset | (3) | 3.0 | | 4.0 | | 5.0 | | ns |
| t _{CNT} | Minimum global clock period | (2) | | 8.6 | | 11.5 | | 13.9 | ns |
| f _{CNT} | Maximum internal global clock frequency | (2), (4) | 116.3 | | 87.0 | | 71.9 | | MHz |
| t _{ACNT} | Minimum array clock period | (2) | | 8.6 | | 11.5 | | 13.9 | ns |
| f _{ACNT} | Maximum internal array clock frequency | (2), (4) | 116.3 | | 87.0 | | 71.9 | | MHz |

Table 28. EPM7128A Internal Timing Parameters (Part 2 of 2) *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | | | Unit |
|------------|----------------------|------------|-------------|------|-----|------|-----|------|-----|------|------|
| | | | -6 | | -7 | | -10 | | -12 | | |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| t_{RD} | Register delay | | | 1.7 | | 2.1 | | 2.8 | | 3.3 | ns |
| t_{COMB} | Combinatorial delay | | | 1.7 | | 2.1 | | 2.8 | | 3.3 | ns |
| t_{IC} | Array clock delay | | | 2.4 | | 3.0 | | 4.1 | | 4.9 | ns |
| t_{EN} | Register enable time | | | 2.4 | | 3.0 | | 4.1 | | 4.9 | ns |
| t_{GLOB} | Global control delay | | | 1.0 | | 1.2 | | 1.7 | | 2.0 | ns |
| t_{PRE} | Register preset time | | | 3.1 | | 3.9 | | 5.2 | | 6.2 | ns |
| t_{CLR} | Register clear time | | | 3.1 | | 3.9 | | 5.2 | | 6.2 | ns |
| t_{PIA} | PIA delay | (2) | | 0.9 | | 1.1 | | 1.5 | | 1.8 | ns |
| t_{LPA} | Low-power adder | (6) | | 11.0 | | 10.0 | | 10.0 | | 10.0 | ns |

Table 30. EPM7256A Internal Timing Parameters (Part 2 of 2) *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | | | Unit |
|------------|----------------------|------------|-------------|------|-----|------|-----|------|-----|------|------|
| | | | -6 | | -7 | | -10 | | -12 | | |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| t_{COMB} | Combinatorial delay | | | 1.6 | | 2.0 | | 2.7 | | 3.2 | ns |
| t_{IC} | Array clock delay | | | 2.7 | | 3.4 | | 4.5 | | 5.4 | ns |
| t_{EN} | Register enable time | | | 2.5 | | 3.1 | | 4.2 | | 5.0 | ns |
| t_{GLOB} | Global control delay | | | 1.1 | | 1.4 | | 1.8 | | 2.2 | ns |
| t_{PRE} | Register preset time | | | 2.3 | | 2.9 | | 3.8 | | 4.6 | ns |
| t_{CLR} | Register clear time | | | 2.3 | | 2.9 | | 3.8 | | 4.6 | ns |
| t_{PIA} | PIA delay | (2) | | 1.3 | | 1.6 | | 2.1 | | 2.6 | ns |
| t_{LPA} | Low-power adder | (6) | | 11.0 | | 10.0 | | 10.0 | | 10.0 | ns |

Notes to tables:

- (1) These values are specified under the recommended operating conditions shown in [Table 14 on page 28](#). See [Figure 12](#) for more information on switching waveforms.
- (2) These values are specified for a PIA fan-out of one LAB (16 macrocells). For each additional LAB fan-out in these devices, add an additional 0.1 ns to the PIA timing value.
- (3) This minimum pulse width for preset and clear applies for both global clear and array controls. The t_{LPA} parameter must be added to this minimum width if the clear or reset signal incorporates the t_{LAD} parameter into the signal path.
- (4) This parameter is measured with a 16-bit loadable, enabled, up/down counter programmed into each LAB.
- (5) Operating conditions: $V_{CCIO} = 2.5 \pm 0.2$ V for commercial and industrial use.
- (6) The t_{LPA} parameter must be added to the t_{LAD} , t_{LAC} , t_{IC} , t_{EN} , t_{SEXP} , t_{ACL} , and t_{CPPW} parameters for macrocells running in low-power mode.

Power Consumption

Supply power (P) versus frequency (f_{MAX} , in MHz) for MAX 7000A devices is calculated with the following equation:

$$P = P_{INT} + P_{IO} = I_{CCINT} \times V_{CC} + P_{IO}$$

The P_{IO} value, which depends on the device output load characteristics and switching frequency, can be calculated using the guidelines given in *Application Note 74 (Evaluating Power for Altera Devices)*.

The I_{CCINT} value depends on the switching frequency and the application logic. The I_{CCINT} value is calculated with the following equation:

$$I_{CCINT} = (A \times MC_{TON}) + [B \times (MC_{DEV} - MC_{TON})] + (C \times MC_{USED} \times f_{MAX} \times \log_{LC})$$

Figure 21. 208-Pin PQFP Package Pin-Out Diagram

Package outline not drawn to scale.

